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Simple, 220V, 20mA, Temperature-Compensated, Constant-Current, LED Driver IC

Features

- 5.0 to 220V operating range (V_{A-B})
- 20mA ±10% at 5.0 160V
- 0.01% / °C typical temperature coefficient
- · Packages Types:
 - TO-252 (D-PAK)
 - TO-220
- · Can be paralleled for higher current

Applications

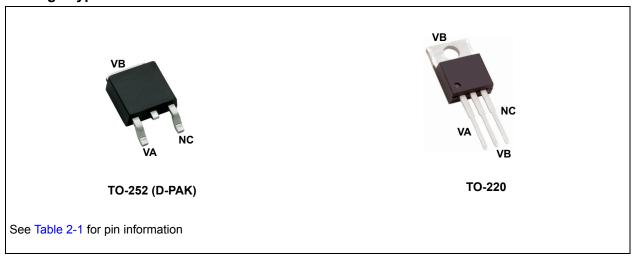
- · Industrial lamp indicators
- · Signage
- · Accent lighting
- · Constant current source
- · Constant current sink

Description

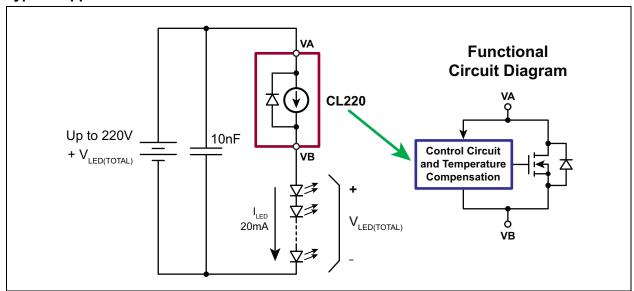
CL220 is a high voltage, temperature-compensated, 20mA constant current regulator. The device operates at up to 220V, and is accurate to $\pm 10\%$ over a 5 - 160V range. The device can be used as a two-terminal, constant-current source or a constant-current sink.

A typical application for CL220 is to drive LEDs with a constant current of 20mA. Multiple CL220s can also be used in parallel to provide higher currents such as 40mA, 60mA, 80mA, and so on. The device is available in the TO-252 (D-PAK) and TO-220 packages.

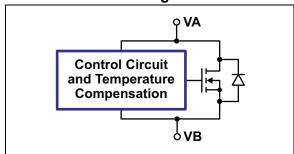
Package Type



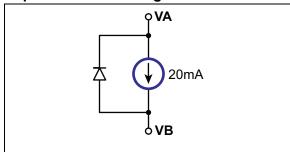
Typical Application Circuit



Functional Circuit Diagram



Equivalent Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS[†]

Operating voltage, V _{A-B}	240V
Operating junction temperature, T _{.1}	40°C to +125°C
Storage temperature, T _S	-55°C to +150°C

† Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 1-1: ELECTRICAL CHARACTERISTICS

Electrical Sp	ecifications: Unless otherwise speci	fied, for a	II specif	ications	$T_{J} = +25$	o°C
Symbol	Parameter	Min	Тур	Max	Units	Conditions
V _{A-B}	Operating voltage	5.0	-	220	V	
ΔΙ _{Α-Β} /ΔΤ	I _{A-B} temperature coefficient	-	0.01	-	%/°C	V _{A-B} = 45V, T _j = -40°C to +100°C (Note 1)
R _{A-B}	Dynamic resistance	-	300	-	kΩ	
		18	20	22		V _{AB} = 4.0 - 160V
I _{AB}	Output current	18	-	25	mA	V _{AB} = 160 - 220V (Fig. 4)
		-	-	22		V _{AB} = 0 - 4.0V
Ios	Turn-on overshoot current	-	25	-	mA	V _T = 45V (Fig. 5) (Note 1)
tos	Overshoot duration	-	1	-	μs	V _T = 45V (Fig. 5) (Note 1)
t _{DLY}	Turn-on delay	-	10	-	μs	V _T = 45V (Fig. 5) (Note 1)
t _{RISE}	Turn-on rise time	-	200	-	ns	V _T = 45V (Fig. 5) (Note 1)

Note 1: Obtained by Characterization; Not 100% tested in production.

TABLE 1-2: THERMAL RESISTANCE, JUNCTION TO AMBIENT

Packago		θ _{ja}		Units	Conditions			
Package	Min	Тур	Max		Conditions			
TO-252 (D-PAK)	-	81	-	°C/W	Soldered to 2.0 cm ² copper area exposed to			
TO-220	-	29	-	°C/W	free air (Note 1)			

Note 1: Obtained by Characterization; Not 100% tested in production.

2.0 PIN DESCRIPTION

The locations of the pins are shown in **Package Type** and **Packaging Information**.

TABLE 2-1: PIN DESCRIPTION

Pin # TO-252	Pin # TO-220	Function	Description
1	1	VA	Current flows into this pin
4	2, 4	VB	Current flows out of this pin
3	3	NC	No connection

3.0 APPLICATION INFORMATION

Figures 3-1- 3-6 show the characteristics and timing for CL220.

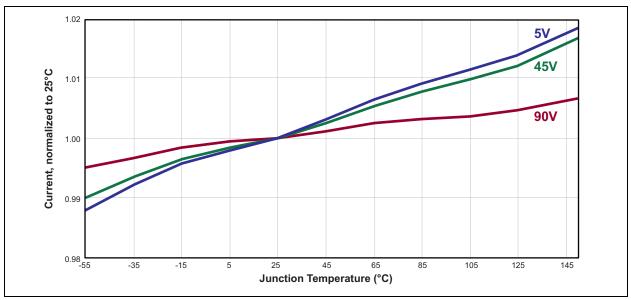


FIGURE 3-1: Temperature Characteristics

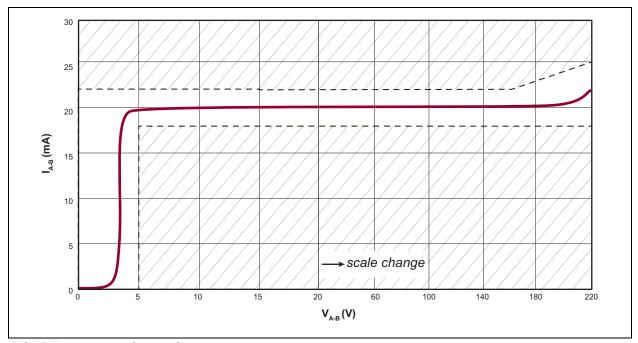


FIGURE 3-2: Output Characteristics

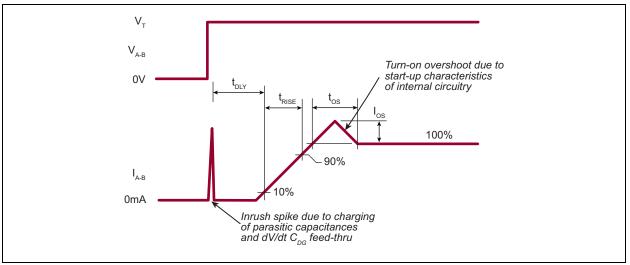


FIGURE 3-3: Timing Diagram

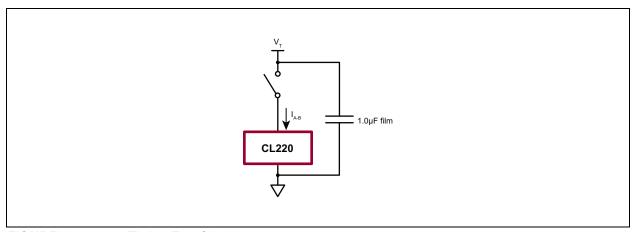


FIGURE 3-4: Timing Test Circuit

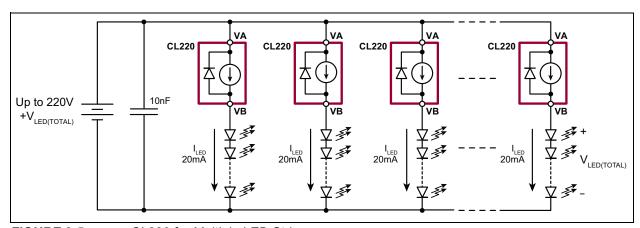


FIGURE 3-5: CL220 for Multiple LED Strings

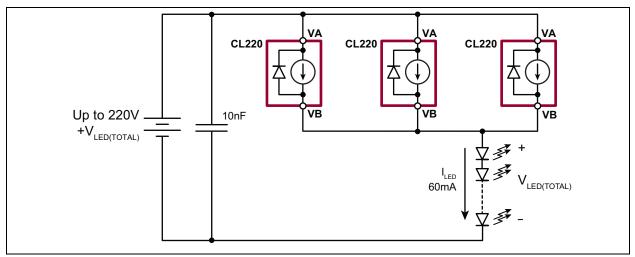


FIGURE 3-6: CL220 for Higher Current

3.1 Functional Circuit and Block Diagram

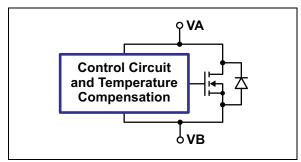


FIGURE 3-7: Functional Circuit Diagram

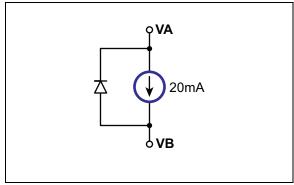
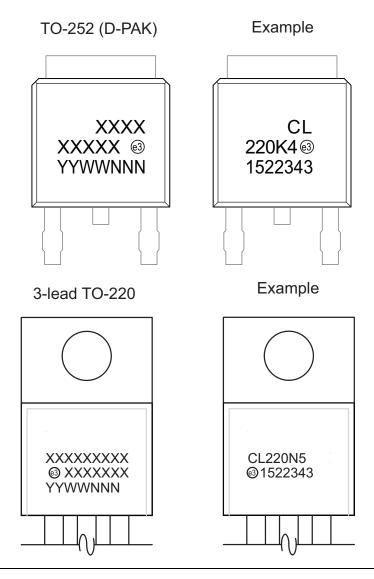


FIGURE 3-8: Block Diagram (Equivalent Functional Circuit)

4.0 PACKAGING INFORMATION

4.1 Package Marking Information



Legend: XX...X Product Code or Customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

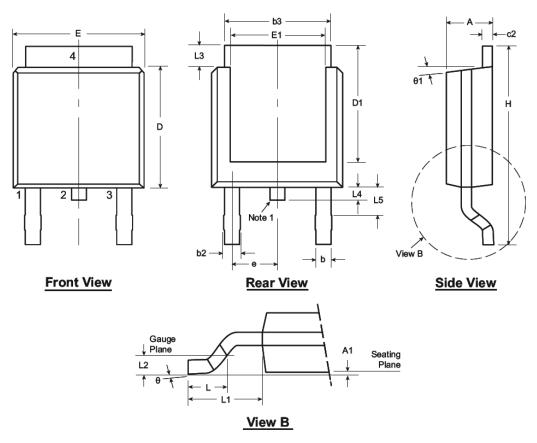
(e3) Pb-free JEDEC[®] designator for Matte Tin (Sn)

This package is Pb-free. The Pb-free JEDEC designator (@3)

can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

3-Lead TO-252 (D-PAK) Package Outline (K4)



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

1. Although 4 terminal locations are shown, only 3 are functional. Lead number 2 was removed.

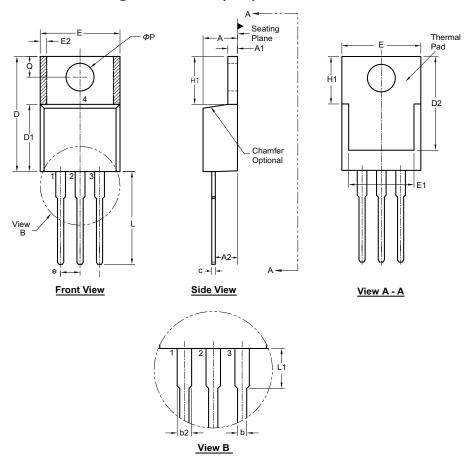
Symb	ol	А	A1	b	b2	b3	c2	D	D1	E	E1	е	Н	L	L1	L2	L3	L4	L5	θ	θ1
Dimen-	MIN	.086	.000*	.025	.030	.195	.018	.235	.205	.250	.170		.370	.055			.035	.025*	.035 [†]	00	0°
sion	NOM	-	-	-	-	,	-	.240	-	-	-	.090 BSC	-	.060	.108 REF	.020 BSC	-	-		1	-
(inches)	MAX	.094	.005	.035	.045	.215	.035	.245	.217*	.265	.200*		.410	.070			.050	.040	.060	10°	15º

JEDEC Registration TO-252, Variation AA, Issue E, June 2004.
* This dimension is not specified in the JEDEC drawing.

Drawings not to scale.

[†] This dimension differs from the JEDEC drawing.

3-Lead TO-220 Package Outline (N5)



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbo	ol	Α	A1	A2	b	b2	С	D	D1	D2	Е	E1	E2	е	H1	L	L1	Q	ФΡ
Dimen-	MIN	.140	.020	.080	.015	.045	.012 [†]	.560	.326 [†]	.474 [†]	.380	.270	0.20*		.230	.500	.200*	.100	.139
sion	NOM	-	-	-	.027	.057	-	-	-	-	-	-	-	.100 BSC	-	-	-	-	-
(inches)	MAX	.190	.055	.120 [†]	.040	.070	.024	.650	.361 [†]	.507	.420	.350	.030		.270	.580	.250	.135	.161

JEDEC Registration TO-220, Variation AB, Issue K, April 2002. * This dimension is not specified in the JEDEC drawing.

Drawings not to scale.

[†] This dimension differs from the JEDEC drawing.

CL220

APPENDIX A: REVISION HISTORY

Revision A (July 2015)

• Update file to new format

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	<u>xx</u> -	<u> </u>		Exa	amples:	
Device	Package Env Options	ironmental Media Type		a) b)	CL220K4-G CL220N5-G	TO-252 package, 2000/reel TO-220 package, 50/Tube
Device:	CL220	= Simple, 220V, 20 mA sated, constant-curr	x, temperature-compen- rent LED driver IC			
Package:	K4 N5	= TO-252 (D-PAK) = TO-220				
Environmental	G	= Lead (Pb)-free/ROI	HS-compliant package			
Media Type:	(blank)	= 2000/Reel for TO-2: = 50/Tube for TO-220				

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